

HSF

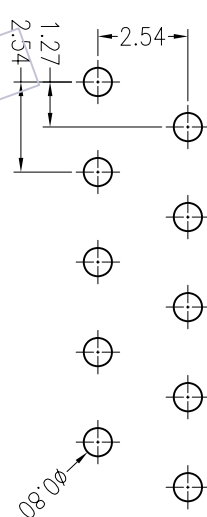
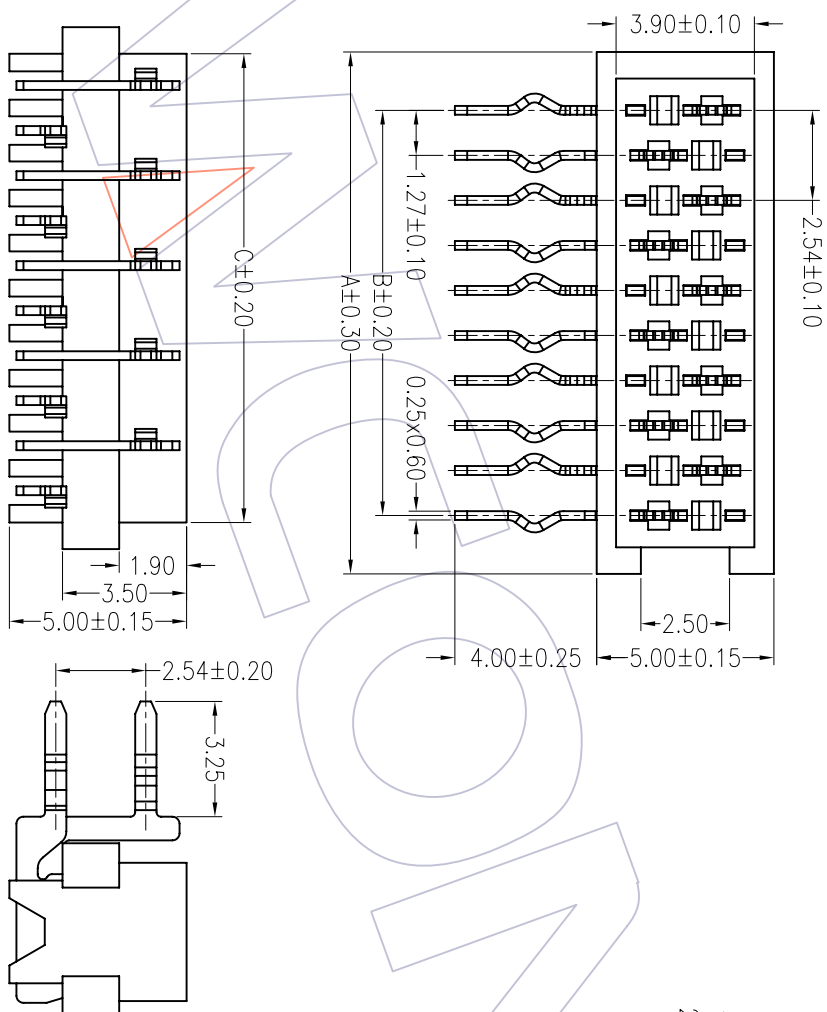
NOTES:

- Rated Current: 1.0AMP
- Contact Resistance: 20mΩ max
- Withstand Voltage: 500V AC/DC
- Insulation Resistance: 1000MΩ min
- Operation Temperature: -40°C to +105°C
- Contact Material: Phosphor Bronze
- Contact Plating: Sn Over Ni
- Insulator Material: High Temperature Plastic UL94V-0

Ordering Information

3900-XX FR SN E N T 01

- No. of Pins: 04P 12P 06P 14P 08P 16P 18P 20P
- Contact Plating: G0=Gold Flash
- Insulator Material: A=PBT C=P46T E=P4A6
- Packing: T=Tube
- SN=Gold Flash/Tin
- S1=3u" Gold/Tin
- S2=5u" Gold/Tin
- S3=10u" Gold/Tin
- S4=15u" Gold/Tin
- S5=30u" Gold/Tin
- SN=Tin



Specification & Ordering Information:

Circuit	Part No.	Dimension			Q'ty /Tube
		A	B	C	
04	3900-04FRSNENT01	7.00	3.81	5.60	82
06	3900-06FRSNENT01	9.54	6.35	8.14	60
08	3900-08FRSNENT01	12.08	8.89	10.68	48
10	3900-10FRSNENT01	14.62	11.43	13.22	39
12	3900-12FRSNENT01	17.16	13.97	15.76	33
14	3900-14FRSNENT01	19.70	16.51	18.30	29
16	3900-16FRSNENT01	22.24	19.05	20.84	26
18	3900-18FRSNENT01	24.78	21.59	23.38	23
20	3900-20FRSNENT01	27.32	24.13	25.92	21

WCON 维峰五金电子有限公司
WAFER HARDWARE ELECTRONICS CO., LTD

Recommended P.C.B Layout (Top Side)
(PCB BOARD TOLERANCE ±0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	SCALE	PART NO.	TITLE:
A0	08/08/25	NEW			X.X X.XX X.XXX	William Chen DESIGN CHECK	1:1 mm A4		Micro Match Socket 90° DIP Without Latch
					Angle DIM	APPROVE			Customer NO.